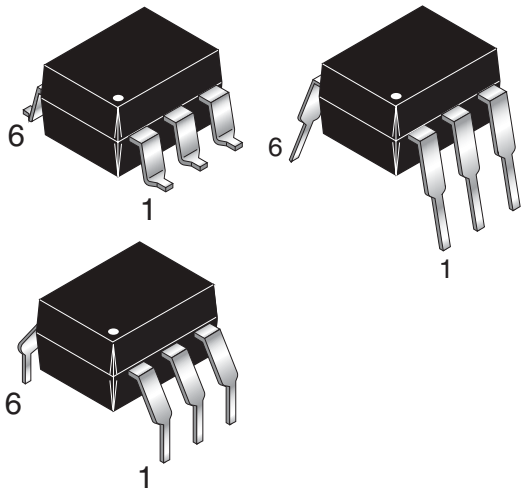
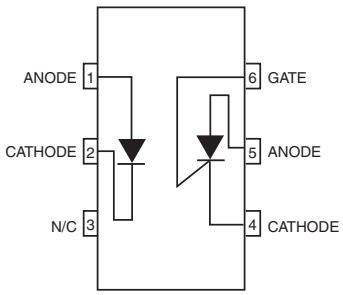
PHOTO SCR OPTOCOUPLERS

H11C1 H11C2 H11C3 H11C4 H11C5 H11C6

PACKAGE



SCHEMATIC



DESCRIPTION

The H11C series consists of a gallium-arsenide infrared emitting diode optically coupled with a light activated silicon controlled rectifier in a dual-in-line package

FEATURES

- High efficiency, low degradation, liquid epitaxial LED
- Underwriters Laboratory (UL) recognized fl File #E90700
- VDE recognized (File #94766) – ordering option .300. (e.g., H11C1.300)
- 200V/400V Peak blocking voltage
- High isolation voltage - 5300V AC (RMS)

APPLICATIONS

- Low power logic circuits
- Telecommunications equipment
- Portable electronics
- Solid state relays
- Interfacing coupling systems of different potentials and impedances.
- 10 A, T^2L compatible, solid state relay
- 25 W logic indicator lamp driver
- 200 V symmetrical transistor coupler (H11C1, H11C2, H11C3)
- 400 V symmetrical transistor coupler (H11C4, H11C5, H11C6)

Parameter	Symbol	Device	Value	Units
TOTAL DEVICE				
Storage Temperature	T_{STG}	All	-55 to +150	°C
Operating Temperature	T_{OPR}	All	-55 to +100	°C
Lead Solder Temperature	T_{SOL}	All	260 for 10 sec	°C
EMITTER				
Continuous Forward Current	I_F	All	60	mA
Reverse Voltage	V_R	All	6	V
Forward Current - Peak (1 µs pulse, 300 pps)	$I_{F(pk)}$	All	3.0	A
LED Power Dissipation	P_D	All	100	mW
Derate above 25°C			1.33	mW/°C
DETECTOR				
Power Dissipation (ambient)	P_D	All	400	mW
Derate linearly above 25°C ambient			5.3	mW/°C
Power Dissipation (case)	P_D	All	1	W
Derate linearly above 25°C case			13.3	mW/°C
Peak Reverse Gate Voltage	V_{GR}	All	6	V
RMS On-State Current	$I_{DM\ (RMS)}$	All	300	mA
Peak On-State Current (100 µS, 1% duty cycle)	$I_{DM\ (Peak)}$	All	10	A
Surge Current (10ms)	$I_{DM\ (Surge)}$	All	5	A
Peak Forward Voltage	V_{DM}	H11C1, H11C2, H11C3	200	V
Peak Forward Voltage	V_{DM}	H11C4, H11C5, H11C6	400	V

ELECTRICAL CHARACTERISTICS (T_A = 25°C Unless otherwise specified.)

INDIVIDUAL COMPONENT CHARACTERISTICS

Parameter	Test Conditions	Symbol	Device	Min	Typ*	Max	Unit
EMITTER							
Input Forward Voltage	I_F = 10 mA	V_F	All		1.2	1.5	V
Reverse Leakage Current	V_R = 3 V	I_R	All			10	µA
Capacitance	V_F = 0 V, f = 1.0 MHz	C_J	All		50		pF
DETECTOR							
Off-State Voltage	R_{GK} = 10kΩ, T_A = 100°C, I_D = 50µA	V_{DM}	H11C1, H11C2, H11C3	200			V
	R_{GK} = 10kΩ, T_A = 100°C, I_D = 150µA		H11C4, H11C5, H11C6	400			
Reverse Voltage	R_{GK} = 10kΩ,T_A = 100°C, I_R = 50µA	V_{RM}	H11C1, H11C2, H11C3	200			V
	R_{GK} = 10kΩ,T_A = 100°C, I_R = 150µA		H11C4, H11C5, H11C6	400			
On-State Voltage	I_{TM} = 300 mA	V_{TM}	All		1.2	1.3	V
Off-State Current	V_{DM} = 200V, T_A = 100°C, I_F = 0 mA, R_{GK} = 10kΩ	I_{DM}	H11C1, H11C2, H11C3			50	µA
	V_{DM} = 400V, T_A = 100°C, I_F = 0 mA, R_{GK} = 10kΩ		H11C4, H11C5, H11C6			150	
Reverse Current	V_{RM} = 200 V, T_A = 100 °C, I_F = 0 mA, R_{GK} = 10kΩ	I_{RM}	H11C1, H11C2, H11C3			50	µA
	V_{RM} = 400 V, T_A = 100 °C, I_F = 0 mA, R_{GK} = 10kΩ		H11C4, H11C5, H11C6			150	

TRANSFER CHARACTERISTICS (T_A = 25°C Unless otherwise specified.)

Characteristics	Test Conditions	Symbol	Device	Min	Typ*	Max	Units
Input Current to Trigger	V_{AK} = 50 V, R_{GK} = 10 kΩ	I_{FT}	H11C1,H11C2, H11C4, H11C5			20	
			H11C3, H11C6			30	mA
	V_{AK} = 100 V, R_{GK} = 27 kΩ		H11C1,H11C2, H11C4, H11C5			11	
			H11C3, H11C6			14	
Coupled dv/dt, input to output (figure 8)		dv/dt	ALL	500			V/µS

*Typical values at T_A = 25°C

ISOLATION CHARACTERISTICS

Characteristic	Test Conditions	Symbol	Min	Typ*	Max	Units
Isolation Voltage	(t = 1 min.) (note 1)	V_{ISO}	5300			V
Isolation Resistance	(note 1) (V_{I-O} = 500 VDC)	R_{ISO}	10^{11}			Ω
Isolation Capacitance	(note 1) (f = 1 MHz, V_{I-O} = 0)	C_{I-O}		0.8		pF

*Typical values at T_A = 25°C

Note
1. For this test, LED pins 1 and 2 are common, and SCR pins 4, 5 and 6 are common.

Figure 1. LED Forward Current vs. Forward Voltage

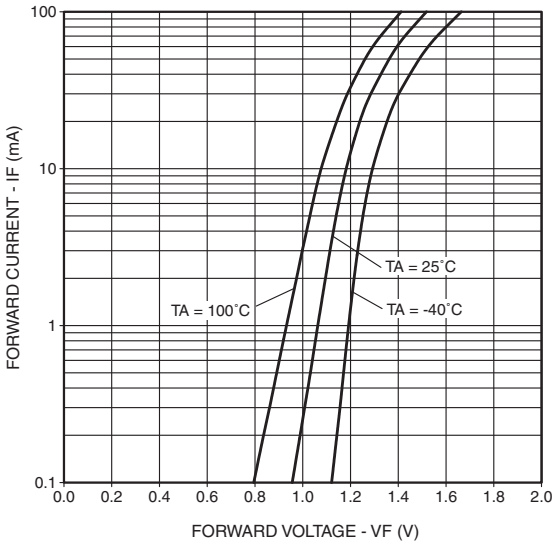


Figure 2. Trigger Current vs Anode-Cathode Voltage

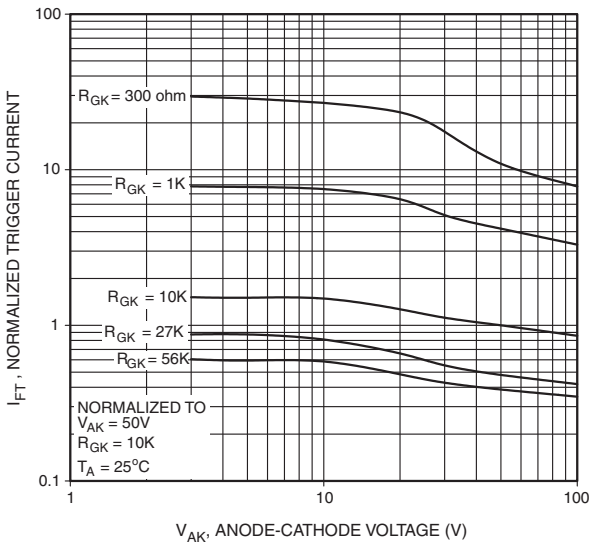


Figure 3. Input Trigger Current vs. Temperature

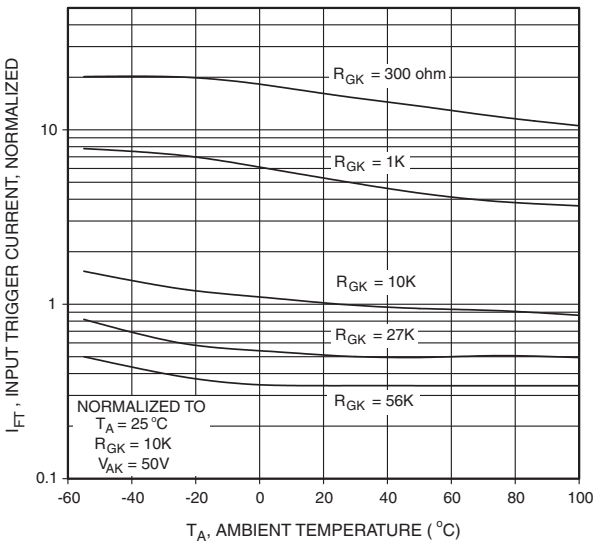


Figure 4. Off-State Current vs. Temperature

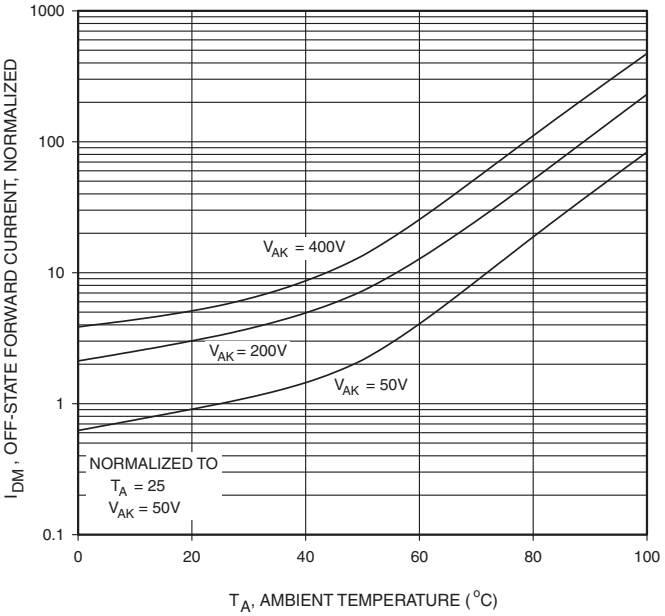


Figure 5. Forward Blocking Voltage, V_{DM} vs. Temperature

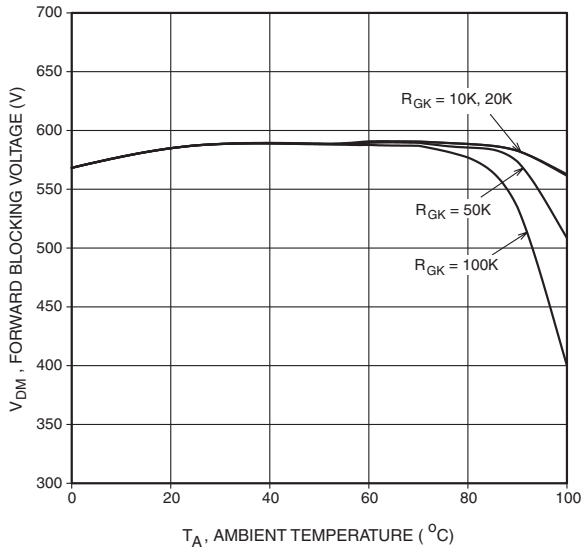


Figure 6. On-State Characteristics

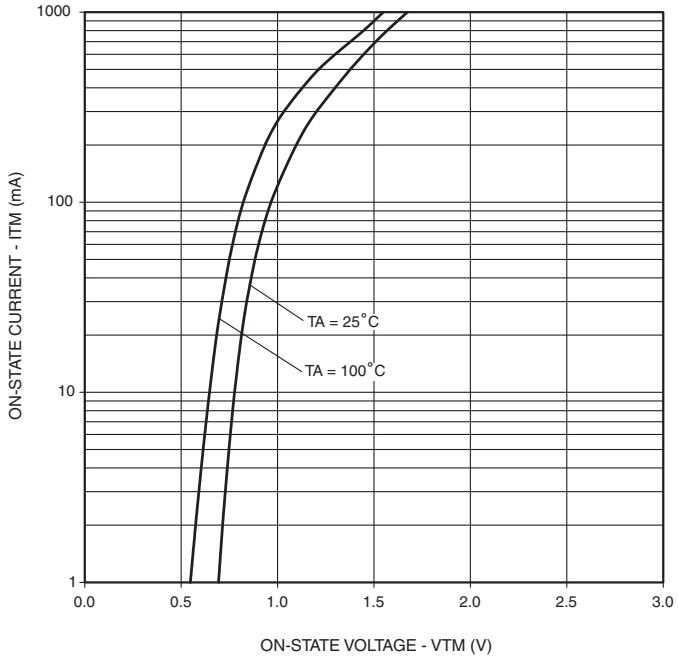
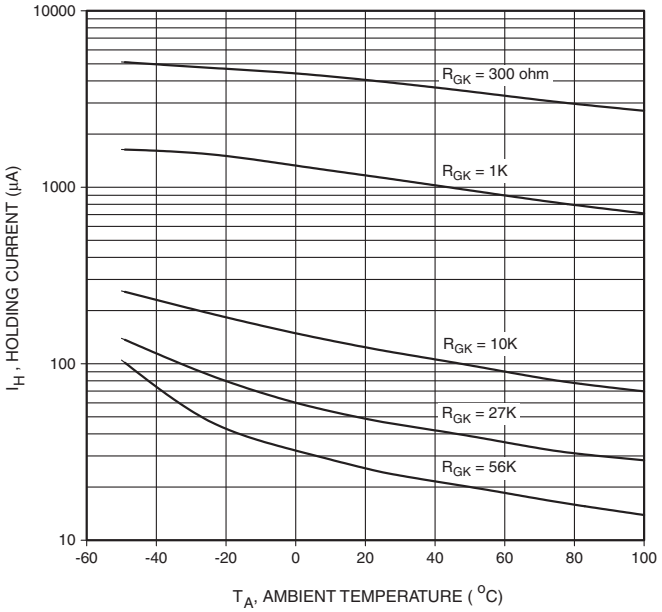


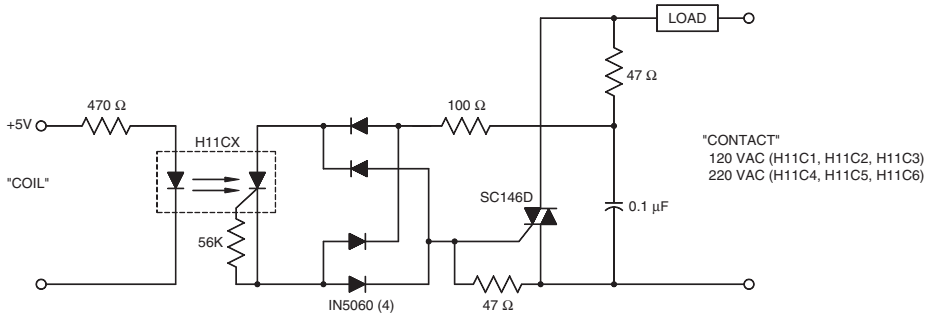
Figure 7. Holding Current, I_H vs. Temperature



TYPICAL APPLICATIONS

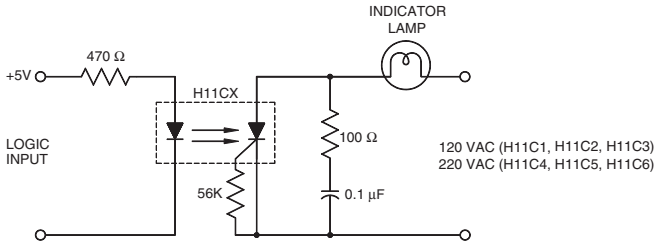
10A, T^2L COMPATIBLE, SOLID STATE RELAY

Use of the H11C4 for high sensitivity, 5300 V isolation capability, provides this highly reliable solid state relay design. This design is compatible with 74, 74S and 74H series T^2L logic systems inputs and 120V AC (H11C1, H11C2, H11C3) or 220V AC (H11C4, H11C5, H11C6) loads up to 10A.



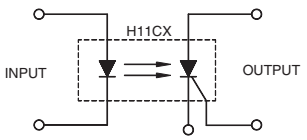
25W, LOGIC INDICATOR LAMP DRIVER

The high surge capability and non-reactive input characteristics of the H11C allow it to directly couple, without buffers, T^2L and DTL logic to indicator alarm devices, without danger of introducing noise and logic glitches.



200V/400V SYMMETRICAL TRANSISTOR COUPLER

Use of the high voltage PNP portion of the H11C provides a 400V transistor capable of conducting positive and negative signals with current transfer ratios of over 1%. This function is useful in remote instrumentation, high voltage power supplies and test equipment. Care should be taken not to exceed the H11C 400mW power dissipation rating when used at high voltages.



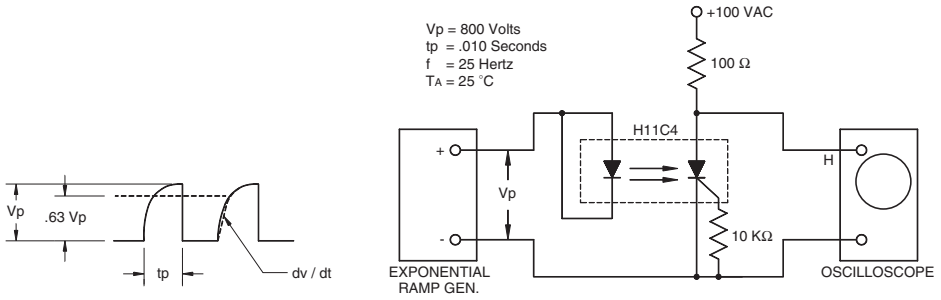
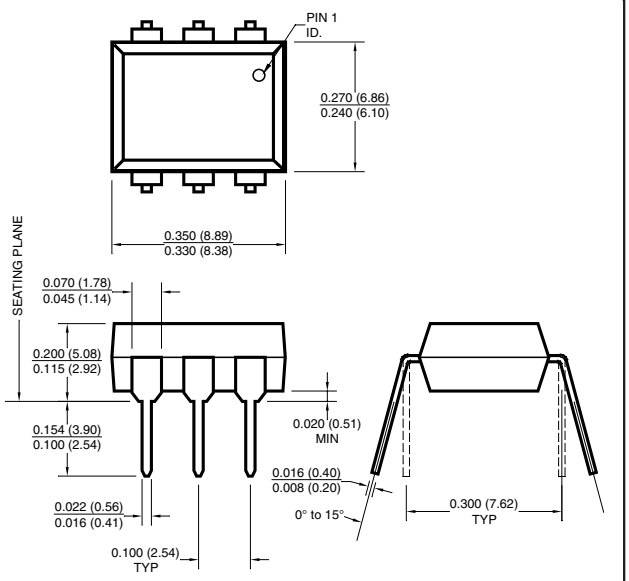
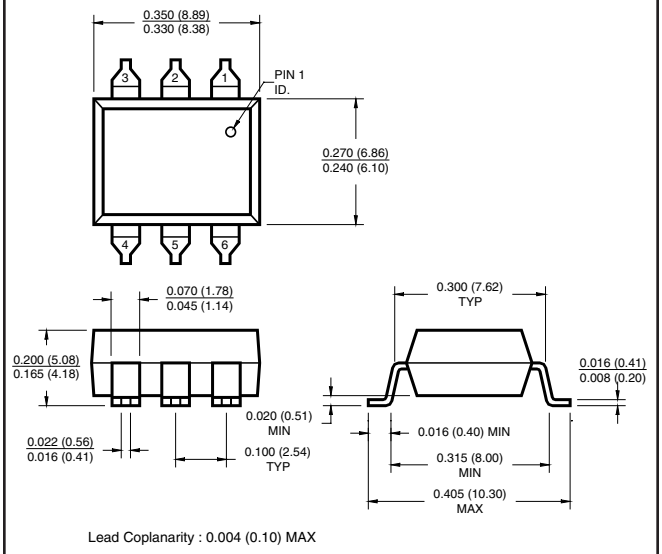


Fig. 8 Coupled dv/dt - Test Circuit

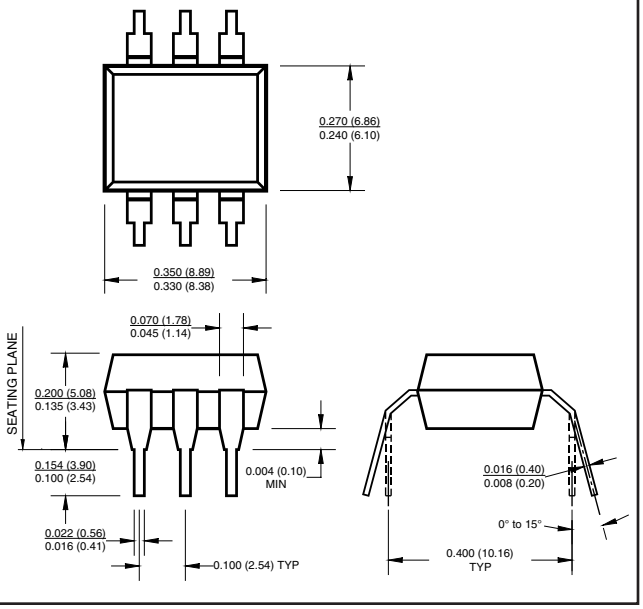
Package Dimensions (Through Hole)



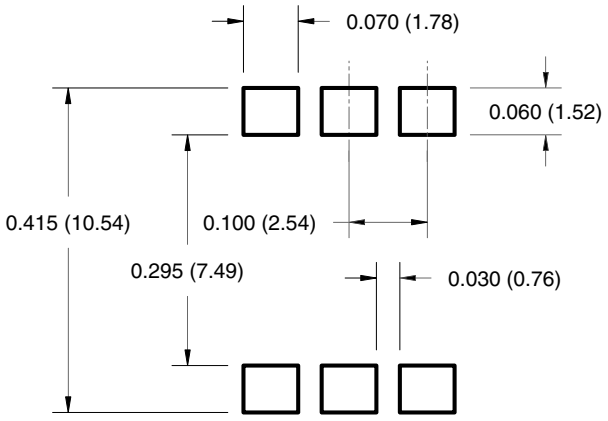
Package Dimensions (Surface Mount)



Package Dimensions (0.4” Lead Spacing)



Recommended Pad Layout for Surface Mount Leadform

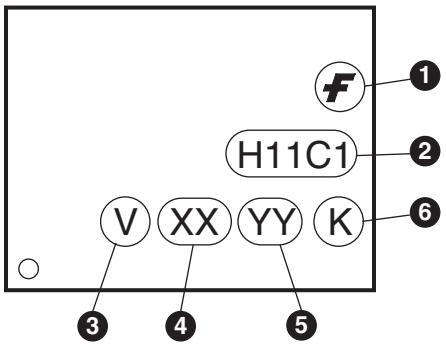


Note
All dimensions are in inches (millimeters)

ORDERING INFORMATION

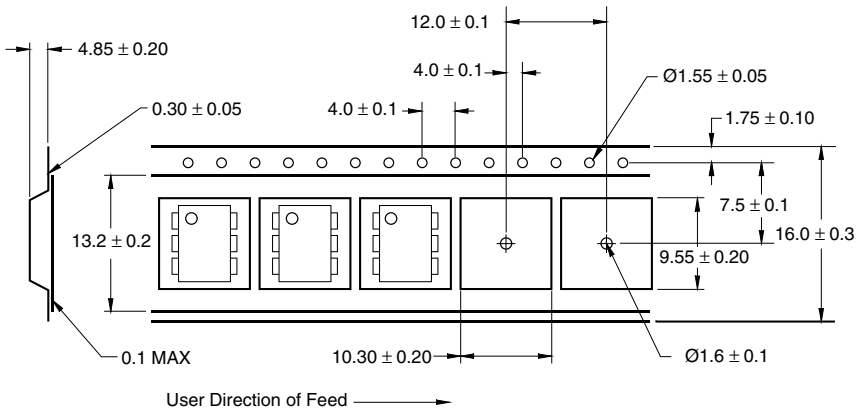
Option	Order Entry Identifier	Description
S	.S	Surface Mount Lead Bend
SD	.SD	Surface Mount; Tape and Reel
W	.W	0.4" Lead Spacing
300	.300	VDE 0884
300W	.300W	VDE 0884, 0.4" Lead Spacing
3S	.3S	VDE 0884, Surface Mount
3SD	.3SD	VDE 0884, Surface Mount, Tape and Reel

MARKING INFORMATION



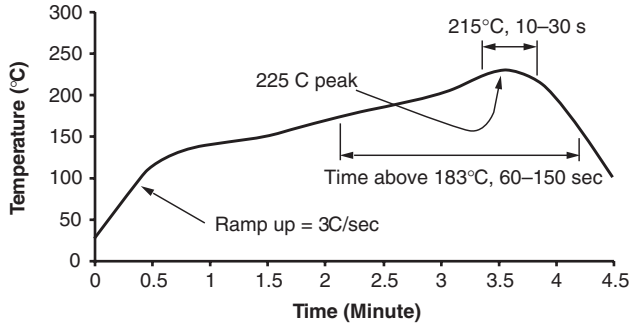
Definitions	
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	Two digit year code, e.g., ‘03’
5	Two digit work week ranging from ‘01’ to ‘53’
6	Assembly package code

Carrier Tape Specifications



NOTE
All dimensions are in inches (millimeters)

Reflow Profile (Black Package, No Suffix)



- Peak reflow temperature: 225°C (package surface temperature)
- Time of temperature higher than 183°C for 60–150 seconds
- One time soldering reflow is recommended

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